Form **PTO-1595** (Rev. 03/01)



U.S. DEPARTMENT OF COMMERCE U.S. Patent and Trademark Office

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OMB No. 0651-0027 (exp. 5/31/2002)	
To the Honorable Commissioner of Patents and Trademarks: P	lease record the attached original documents or copy thereof
Name of conveying party(ies):	2. Name and address of receiving party(ies)
Ryuji Ishiguro, Yoshitomo Osawa, Tateo Oishi, Tomoyuki Asano, and Atsushi Mitsuzawa	Name: Sony Corporation
3-28-02	Internal Address:
A 1 100 - 1 - 1 - 1 - 1 - 1 - 1 - 1 - 1 -	Street Address: 7-35 Kitashinagawa 6-Chome
attached?	Shinagawa-ku
3. Nature of Conveyance:	
x Assignment Merger	(° -2 -3
Security Agreement Change of Name	City: Tokyo
Other	State: Japan Zip: 141-0001.5
Execution Date: February 25,2002	Additional name(s) & Yes x No address(es) attached:
4. Application number(s) or patent number(s):	
If this document is being filed together with a new application, the exe	ecution date of the new application is:
A. Patent Application No.(s): 09/980,952	B. Patent No.(s):
03/300,332	
Additional numbers attach	ed? Yes x No
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved: 1
Name: LERNER, DAVID, LITTENBERG, KRUMHOLZ & MENTLIK, LLP	7. Total fee (37 CFR 3.41) \$40.00
(1)	Enclosed
Street Address: 600 South Avenue West	X Authorized to be charged to deposit account
	8. Deposit account number:
	12-1095
City: State: Zip: Westfield NJ 07090	(Attach duplicate copy of this page if paying by deposit account)
DO NOT USE THIS SPACE	
9. Statement and signature.	
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.	
Robert B. Cohen	Signature March 18, 2002 Date
Name of Person Signing	Olympia 2
Total number of pages including cover sheet, attachments, and documents:3	

04/11/2002 TDIAZ1 00000137 121095 09980952 01 FC:581 40.00 CH

Docket Number: SONYJP 3.3-161

Sony Reference No.: S01P0654US00

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in:

INFORMATION PROCESSING SYSTEM AND METHOD

for which an International Application was filed on April 4, 2001, PCT/JP01/02929, designating the United States;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35, Kitashinagawa 6-chome, Shinagawa-ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto:

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

into which would conflict with this assignment and sale.	
	attorney(s) of record in this application to insert the application number Application Number:, Filing Date:
This assignment executed on the dates ind	licated below.
Ryuji ISHIGURO	
Name of First or Sole Inventor	Execution Date of U.S. Patent Application
Tokyo, Japan	
Residence of First or Sole Inventor	
Ryui Achianin	February 13 Zor Z

Signature of First or Sole Inventor

PATENT REEL: 012771 FRAME: 0110

Date of this Assignment

Docket Number: SONYJP 3.3-161

Sony Reference No. S01P0654US00

Yoshitomo OSAWA Name of Second Joint Inventor Execution Date of U.S. Patent Application Kanagawa, Japan Residence of Second Joint Inventor Tateo OISHI Name of Third Joint Inventor Execution Date of U.S. Patent Application Saitama, Japan Residence of Third Joint Inventor Tomoyuki ASANO Execution Date of U.S. Patent Application Name of Fourth Joint Inventor Kanagawa, Japan Residence of Fourth Joint Inventor Atsushi MITSUZAWA Execution Date of U.S. Patent Application Name of Fifth Joint Inventor Tokyo, Japan Residence of Fifth Joint Inventor February 13, 2002
Date of this Assignment

RECORDED: 03/28/2002

PATENT REEL: 012771 FRAME: 0111